

Power line chokes

I core chokes

500 V AC, 4 ... 40 A, 0.056 ... 5.6 mH

Series/Type: **B82505W**

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Power line chokes

B82505W

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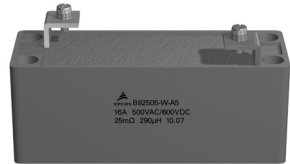
Rated voltage 500 V AC/600 V DC

Rated current 4 ... 40 A

Rated inductance 0.056 ... 5.6 mH

Construction

- I core choke
- Rectangular plastic case
- Resin potting



Features

- Low power dissipation
- Suppression of broadband interference
- Compact design
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2)
- RoHS-compatible

Applications

- Suppression of symmetrical and asymmetrical interference
- High-performance power supplies
- Industrial applications

Terminals

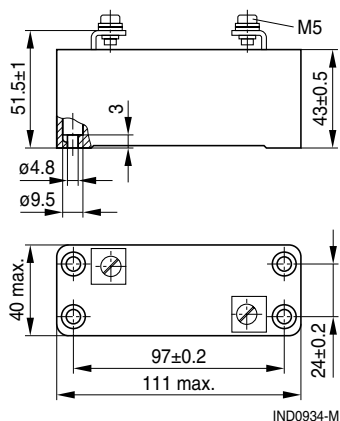
Screw terminals M5

Marking

Manufacturer, ordering code, rated inductance, rated voltage, rated current, DC resistance, date of manufacture (MM.YY)

Delivery mode

Cardboard box

Dimensional drawing


Tolerances to ISO 2768-C
unless otherwise noted.

Dimensions in mm

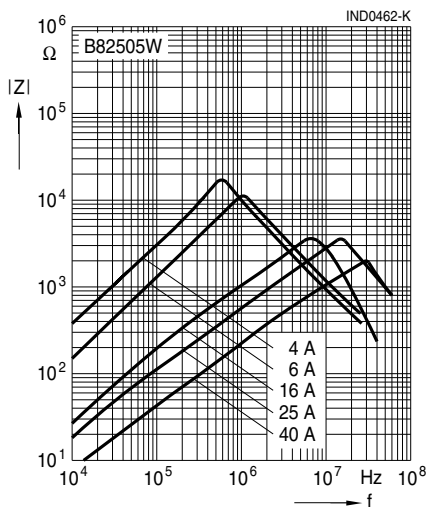
Technical data and measuring conditions

Rated voltage V_R	500 V AC (50/60 Hz) / 600 V DC During operation between winding and metal parts (VDE 0565-2).
Test voltage V_{test}	2800 V AC, 2 s (winding/core) 2800 V AC, 2 s (winding/case)
Rated temperature T_R	+60 °C
Rated current I_R	Referred to 50 Hz and rated temperature
Permissible operating current at 400 Hz	$0.6 \cdot I_R$
Rated inductance L_R	Measured with Agilent 4284A at 0.1 mA, +20 °C Measuring frequency: $L_R \leq 1 \text{ mH} = 100 \text{ kHz}$ $L_R > 1 \text{ mH} = 10 \text{ kHz}$
Inductance tolerance	±20% at +20 °C
DC resistance R_{typ}	Measured at +20 °C, typical values
Storage conditions (packaged)	-25 °C ... +40 °C, ≤ 75% RH
Climatic category	40/125/56 (to IEC 60068-1)
Weight	Approx. 600 g

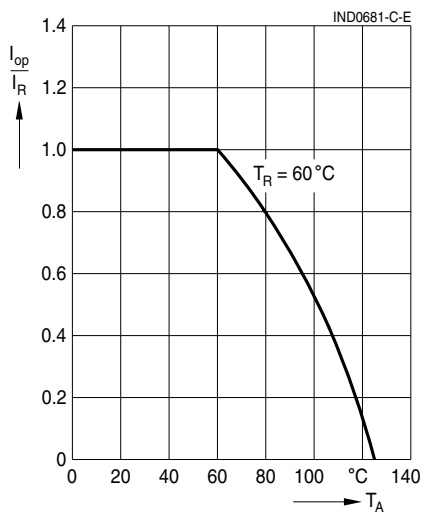
Characteristics and ordering codes

I_R A	L_R mH	R_{typ} Ω	Ordering code
4	5.6	0.480	B82505W0000A002
6	2.2	0.220	B82505W0000A003
8	1.2	0.075	B82505W0000A008
16	0.29	0.025	B82505W0000A015
25	0.15	0.015	B82505W0000A006
40	0.056	0.006	B82505W0000A007

Impedance $|Z|$ versus frequency f
measured at +20 °C, typical values



Current derating I_{op}/I_R
versus ambient temperature T_A



Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
 - Particular attention should be paid to the derating curves given there. Derating must be applied in case the ambient temperature in the application exceeds the rated temperature of the component.
 - Ensure the operation temperature (which is the sum of the ambient temperature and the temperature rise caused by losses / self-heating) of the component in the application does not exceed the maximum value specified in the climatic category.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted in customer applications:
 - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
 - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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